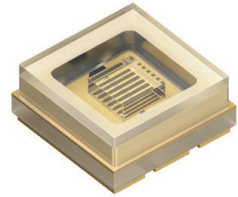


# SU CULDN1.VC

## OSLON® UV 3636

This compact UV-C LED is part of the OSLON UV series.

It allows a flexible design for any application which requires UV-C radiation for e.g. disinfection, purification, treatment or sensing.



## Applications

- Equipment Illumination (e.g. Curing, Endoscope)
- Smoke/Dust/Particle Sensing
- UV-C Air Disinfection
- UV-C Surface Disinfection
- UV-C Water Disinfection

## Features:

- Package: Ceramic package with integrated glass cover
- Chip technology: AlGaIn based Flip chip
- Typ. Radiation: 120° (Lambertian emitter)
- Color:  $\lambda_{\text{peak}} = 275 \text{ nm}$  (• ultraviolet (UV-C))
- ESD: 5 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)
- Radiant Flux: typ. 42 mW
- Radiant Efficiency: typ. 2.1 %

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## Ordering Information

| Type                      | Radiant Intensity <sup>1)</sup><br>$I_F = 350 \text{ mA}$<br>$I_e$ | Ordering Code |
|---------------------------|--|---------------|
| SU CULDN1.VC-MAMP-67-4E4F | 30.0 ... 100.0 mW  | Q65113A2365   |

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## Maximum Ratings

| Parameter   | Symbol    |      | Values |
|---|-----------|------|--------|
| Operating Temperature   | $T_{op}$  | min. | -40 °C |
|   |           | max. | 60 °C  |
| Storage Temperature   | $T_{stg}$ | min. | -40 °C |
|   |           | max. | 100 °C |
| Junction Temperature  | $T_j$     | max. | 85 °C  |
| Forward current<br>$T_s = 25\text{ °C}$                       | $I_F$     | min. | 1 mA   |
|   |           | max. | 500 mA |
| Surge Current<br>$T_s = 25\text{ °C}$                         | $I_{FS}$  | max. | 750 mA |
| Reverse voltage <sup>2)</sup><br>$T_s = 25\text{ °C}$         | $V_R$     | max. | 5 V    |
| ESD withstand voltage<br>acc. to ANSI/ESDA/JEDEC JS-001 (HBM) | $V_{ESD}$ |      | 5 kV   |

## Characteristics

$I_F = 350 \text{ mA}$ ;  $T_s = 25 \text{ °C}$

| Parameter   | Symbol                  |                      | Values                     |
|---|-------------------------|----------------------|----------------------------|
| Peak Wavelength <sup>3)</sup>   | $\lambda_{\text{peak}}$ | min.<br>typ.<br>max. | 270 nm<br>275 nm<br>280 nm |
| Viewing angle at 50% $I_V$  | $2\varphi$              | typ.                 | 120 °                      |
| Forward Voltage <sup>4)</sup><br>$I_F = 350 \text{ mA}$                                 | $V_F$                   | min.<br>typ.<br>max. | 5.00 V<br>5.70 V<br>6.00 V |
| Real thermal resistance junction/solderpoint <sup>5)</sup>                              | $R_{\text{thJS real}}$  | typ.                 | 6.3 K / W                  |
| Electrical thermal resistance junction/solderpoint<br>with efficiency $\eta_e = 2.1 \%$ | $R_{\text{thJS elec.}}$ | typ.                 | 6.2 K / W                  |

## Brightness Groups

| Group | Radiant Intensity <sup>1)</sup><br>$I_F = 350 \text{ mA}$<br>min.<br>$I_e$ | Radiant Intensity <sup>1)</sup><br>$I_F = 350 \text{ mA}$<br>max.<br>$I_e$ |
|-------|--|--|
| MA    | 30.0 mW  | 35.0 mW  |
| MB    | 35.0 mW  | 40.0 mW  |
| MC    | 40.0 mW  | 45.0 mW  |
| MD    | 45.0 mW  | 50.0 mW  |
| ME    | 50.0 mW  | 55.0 mW  |
| MF    | 55.0 mW  | 60.0 mW  |
| MG    | 60.0 mW  | 65.0 mW  |
| MH    | 65.0 mW  | 70.0 mW  |
| MJ    | 70.0 mW  | 75.0 mW  |
| MK    | 75.0 mW  | 80.0 mW  |
| ML    | 80.0 mW  | 85.0 mW  |
| MM    | 85.0 mW  | 90.0 mW  |
| MN    | 90.0 mW  | 95.0 mW  |
| MP    | 95.0 mW  | 100.0 mW   |

## Forward Voltage Groups

| Group | Forward Voltage <sup>4)</sup><br>$I_F = 350 \text{ mA}$<br>min.<br>$V_F$ | Forward Voltage <sup>4)</sup><br>$I_F = 350 \text{ mA}$<br>max.<br>$V_F$ |
|-------|--|--|
| 4E    | 5.00 V   | 5.50 V   |
| 4F    | 5.50 V   | 6.00 V   |

## Wavelength Groups

| Group | Peak Wavelength <sup>3)</sup><br>min.<br>$\lambda_{\text{peak}}$ | Peak Wavelength <sup>3)</sup><br>max.<br>$\lambda_{\text{peak}}$ |
|-------|--|--|
| 6     | 270 nm   | 275 nm   |
| 7     | 275 nm   | 280 nm   |

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## Group Name on Label

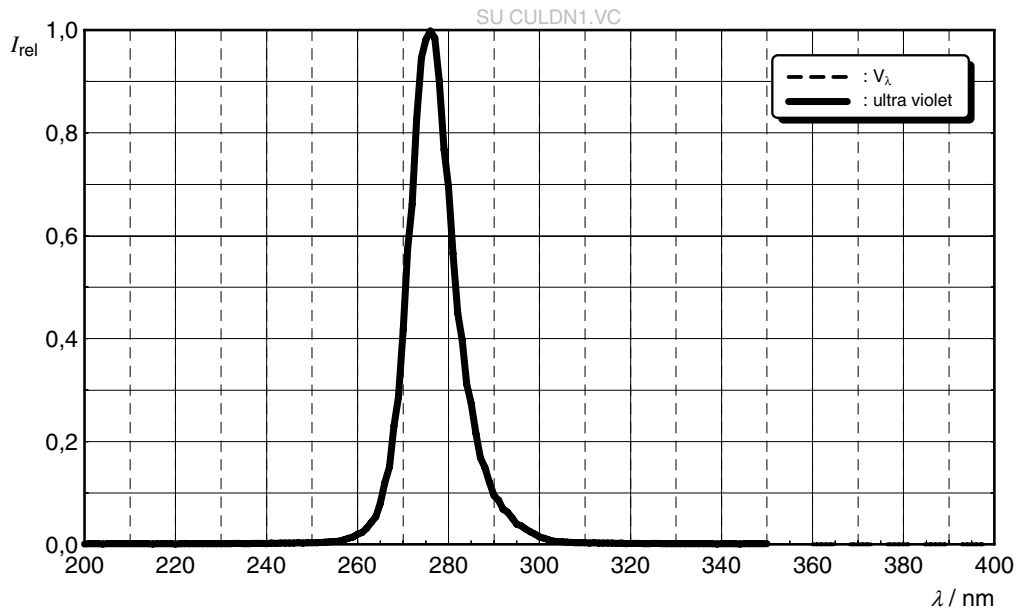
**Example: MA-6-4E**

| Brightness | Wavelength | Forward Voltage |
|------------|------------|-----------------|
| MA         | 6          | 4E              |

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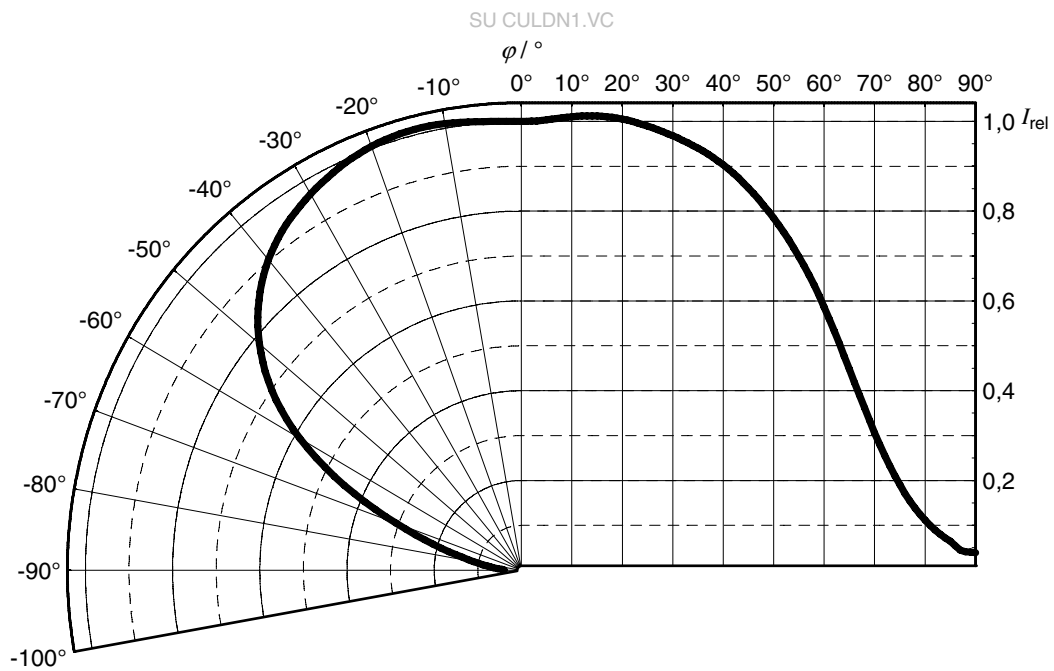
### Relative Spectral Emission <sup>6)</sup>

$I_{rel} = f(\lambda); I_F = 350 \text{ mA}; T_S = 25 \text{ }^\circ\text{C}$



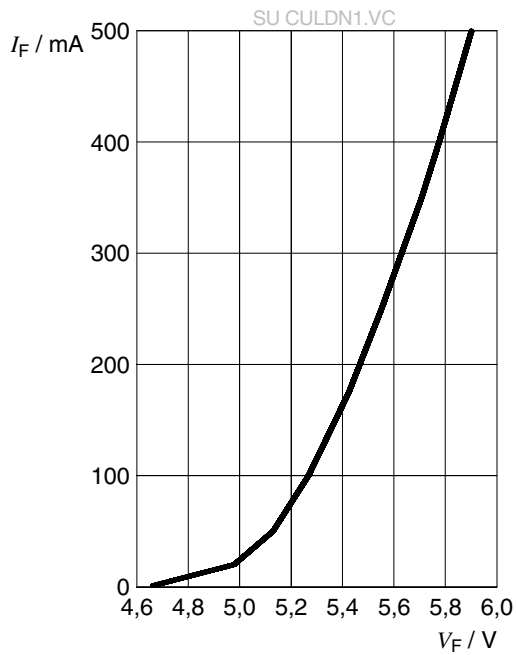
### Radiation Characteristics <sup>6)</sup>

$I_{rel} = f(\phi); T_S = 25 \text{ }^\circ\text{C}$



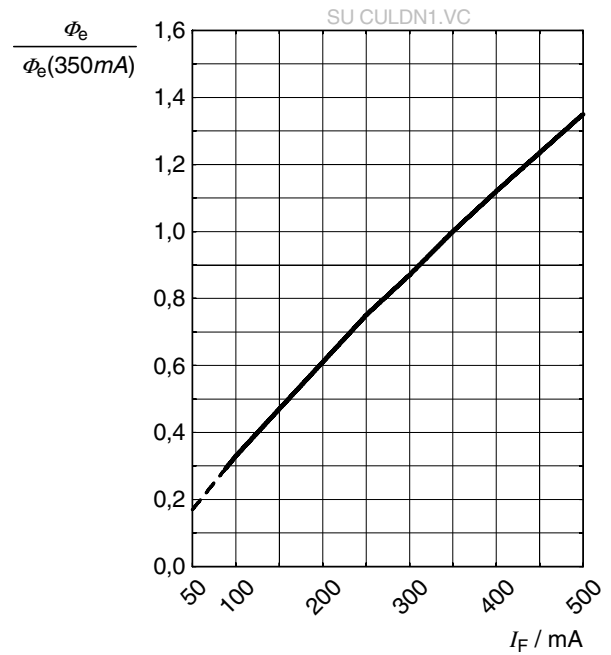
**Forward current** <sup>6)</sup>

$I_F = f(V_F); T_S = 25\text{ °C}$



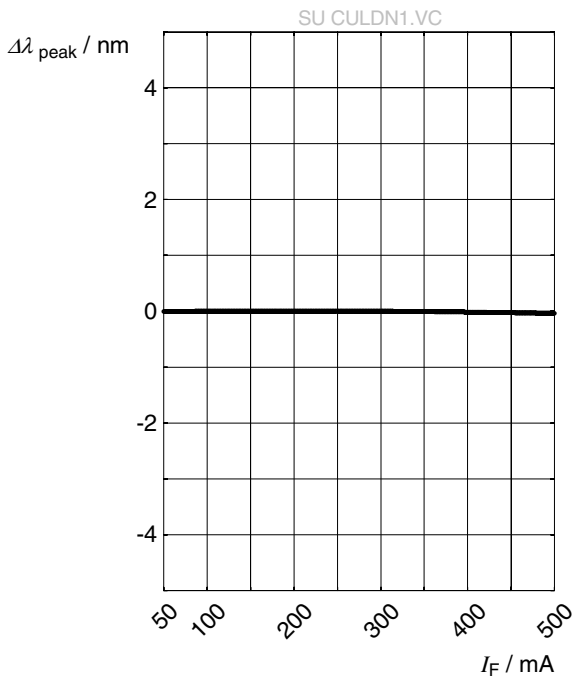
**Relative Radiant Power** <sup>6), 7)</sup>

$\Phi_E / \Phi_E(350\text{ mA}) = f(I_F); T_S = 25\text{ °C}$



**Peak Wavelength** <sup>6)</sup>

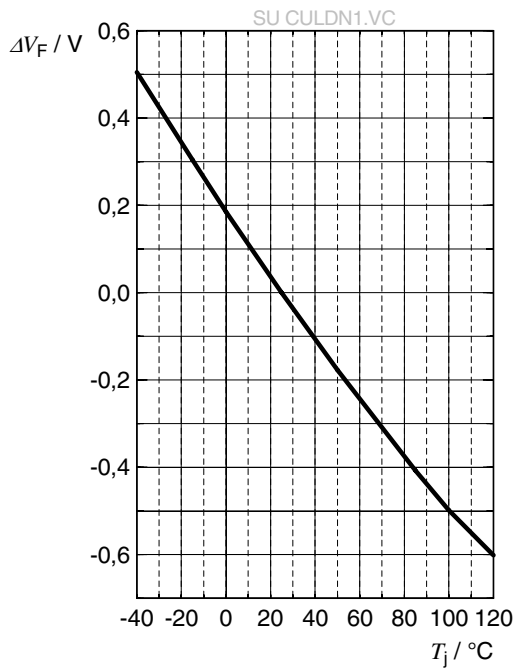
$\lambda_{\text{peak}} = f(T_j); I_F = 350\text{ mA}$





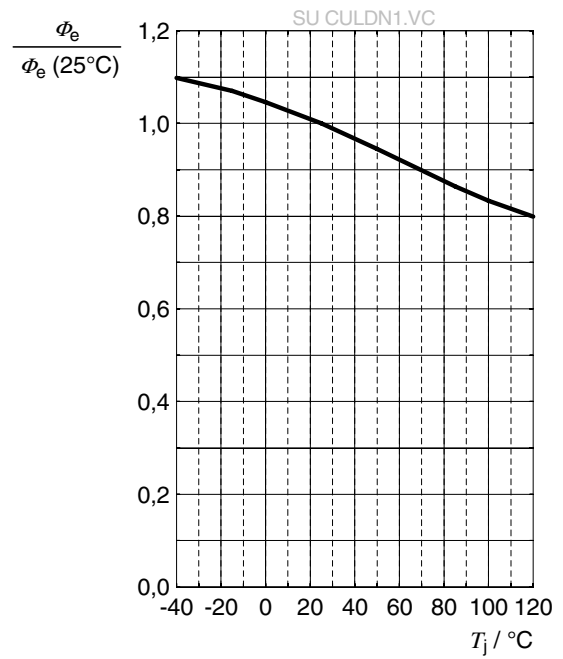
**Forward Voltage** <sup>6)</sup>

$$\Delta V_F = V_F - V_F(25\text{ °C}) = f(T_j); I_F = 350\text{ mA}$$



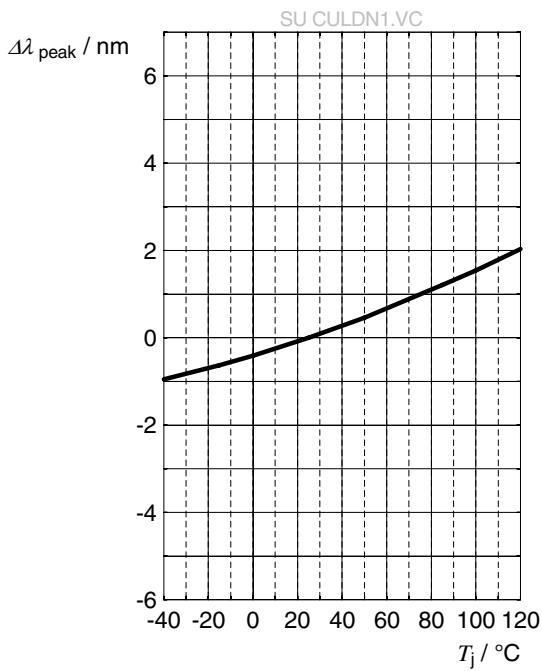
**Relative Radiant Power** <sup>6)</sup>

$$\Phi_E / \Phi_E(25\text{ °C}) = f(T_j); I_F = 350\text{ mA}$$



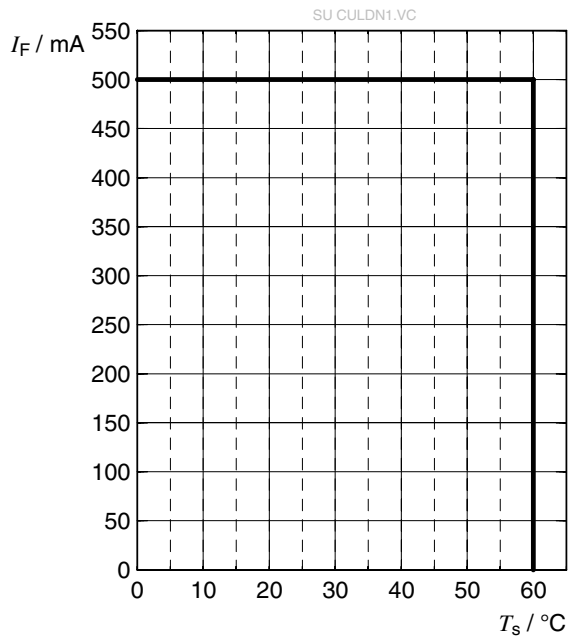
**Peak Wavelength** <sup>6)</sup>

$$\lambda_{\text{peak}} = f(T_j); I_F = 350\text{ mA}$$

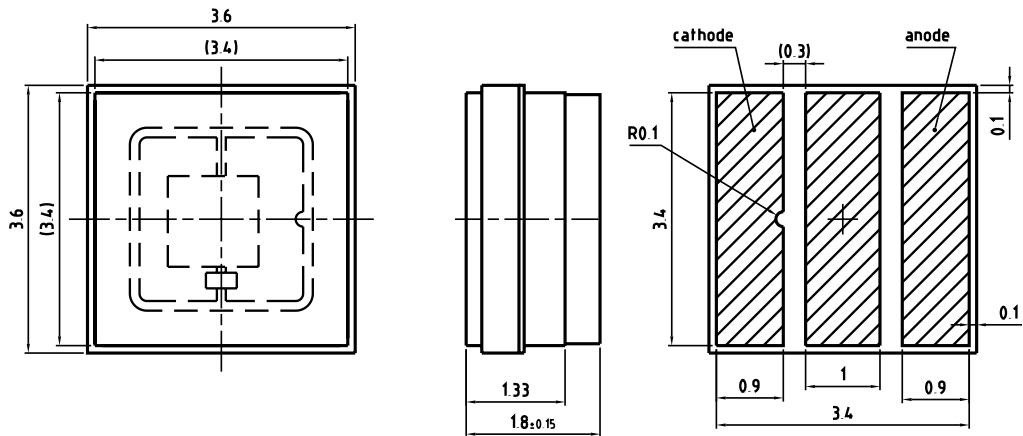



## Max. Permissible Forward Current

$$I_F = f(T)$$



## Dimensional Drawing <sup>8)</sup>



general tolerance  $\pm 0.1$   
 lead finish Au 

C67062-A0383-A1-02

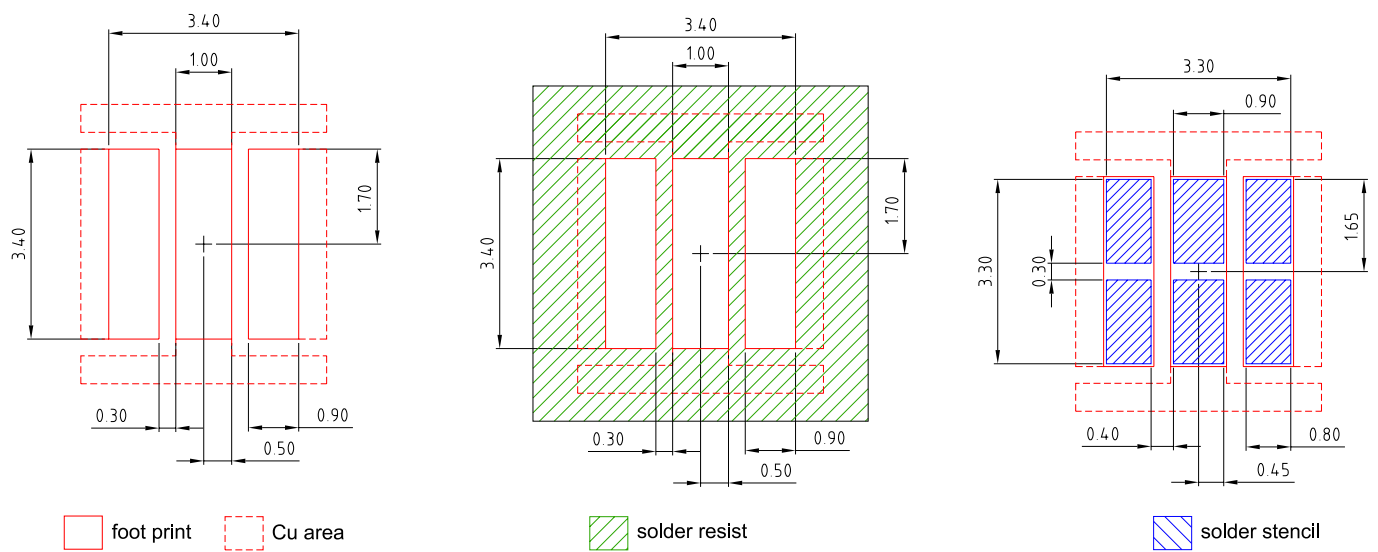
## Further Information:

**Approximate Weight:** 82.6 mg

**Package marking:** Cathode

**ESD advice:** LED is protected by ESD device which is connected in parallel to LED-Chip.

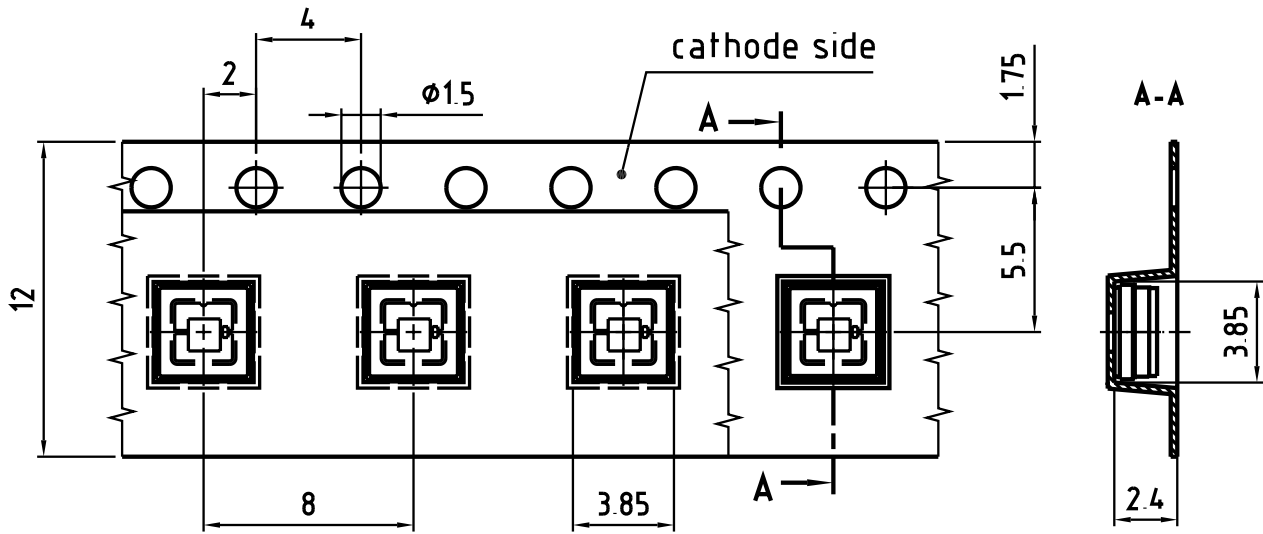
Recommended Solder Pad <sup>8)</sup>



E067.0346.19-01

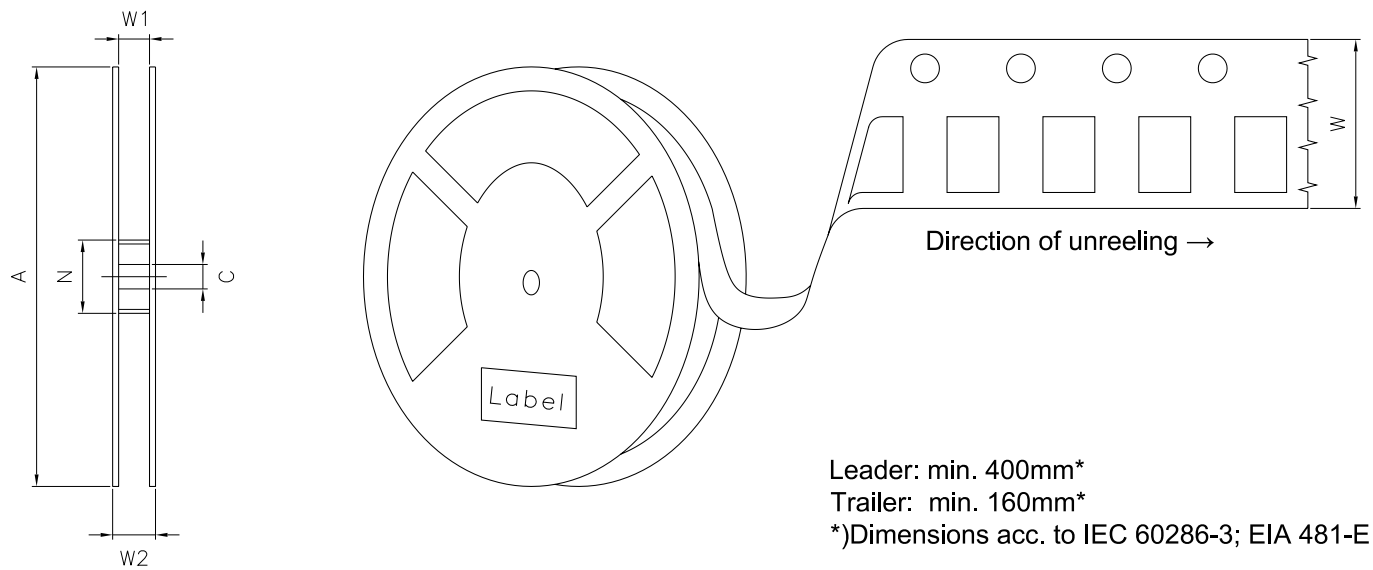
For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for any kind of wet cleaning or ultrasonic cleaning.

Taping <sup>8)</sup>



C67062-A0383-B2-01

**Tape and Reel** <sup>9)</sup>



**Reel Dimensions**

| A      | W                   | N <sub>min</sub> | W <sub>1</sub> | W <sub>2max</sub> | Pieces per PU |
|--------|---------------------|------------------|----------------|-------------------|---------------|
| 180 mm | 12 + 0.3 / - 0.1 mm | 60 mm            | 12.4 + 2 mm    | 18.4 mm           | 100           |

### Barcode-Product-Label (BPL)

**OSRAM Opto Semiconductors** LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890 ML Temp ST  
X XXX °C X

(1T) LOT NO: 1234567890 (9D) D/C: 1234 Pack: RXX  
DEMY XXX  
X\_X123\_1234.1234 X

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and product name at the top left. To the right are fields for 'LX XXXX' and 'BIN1: XX-XX-X-XXX-X'. Below the logo is a 'RoHS Compliant' statement. The label features three horizontal barcode sections. The first is labeled '(6P) BATCH NO: 1234567890' and is accompanied by a 'No moisture' symbol and 'ML Temp ST X XXX °C X'. The second is labeled '(1T) LOT NO: 1234567890' and '(9D) D/C: 1234', with 'Pack: RXX', 'DEMY XXX', and 'X\_X123\_1234.1234 X' below it. The third is labeled '(X) PROD NO: 123456789(Q)QTY: 9999' and '(G) GROUP: XX-XX-X-X'. A square QR code is located on the right side of the label.

OHA04563

### Dry Packing Process and Materials <sup>8)</sup>



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

## Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into high risk group – RG3. WARNING - UV emitted from this product. Avoid eye and skin contact to unshielded product.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit [www.osram-os.com/appnotes](http://www.osram-os.com/appnotes)



## Disclaimer

### **Attention please!**

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### **Product and functional safety devices/applications or medical devices/applications**

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

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## Glossary

- 1) **Brightness:** Brightness groups are tested at a current pulse duration of 25 ms and a tolerance of  $\pm 11\%$ .
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Wavelength:** Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of  $\pm 1$  nm.
- 4) **Forward Voltage:** Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of  $\pm 0.1$  V.
- 5) **Thermal Resistance:**  $R_{th\ max}$  is based on statistic values ( $6\sigma$ ).
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

## Revision History

| Version | Date       | Change          |
|---------|------------|-----------------|
| 1.0     | 2020-11-27 | Initial Version |

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